

512K x 8 (4-MBIT) DYNAMIC RAM WITH FAST PAGE MODE

PRELIMINARY INFORMATION AUGUST 2001

FEATURES

- · Fast access and cycle time
- TTL compatible inputs and outputs
- Refresh Interval: 1024 cycles/16 ms
- Refresh Mode: RAS-Only, CAS-before-RAS (CBR), and Hidden
- · JEDEC standard pinout
- Single power supply:
 - -- 5V ± 10% (IS41C85125)
 - -- 3.3V ± 10% (IS41LV85125)
- · Industrial temperature available

DESCRIPTION

The *ISSI* IS41C85125 and IS41LV85125 are 512,288 x 8-bit high-performance CMOS Dynamic Random Access Memories. Fast Page Mode allows 1024 random accesses within a single row with access cycle time as short as 12 ns per 8-bit word.

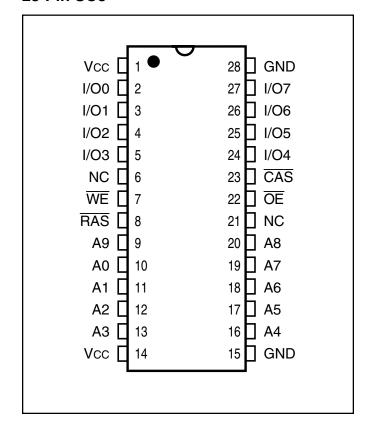
These features make the IS41C85125 and the IS41LV85125 ideally suited for high band-width graphics, digital signal processing, high-performance computing systems, and peripheral applications.

The IS41C85125 and IS41LV85125 are available in a 28-pin, 400-mil SOJ package.

KEY TIMING PARAMETERS

| Parameter | -35 | -60 | Unit |
|---------------------------------------|-----|-----|------|
| Max. RAS Access Time (trac) | 35 | 60 | ns |
| Max. CAS Access Time (tcac) | 10 | 15 | ns |
| Max. Column Address Access Time (taa) | 18 | 30 | ns |
| Min. Fast Page Mode Cycle Time (tpc) | 12 | 25 | ns |
| Min. Read/Write Cycle Time (tRC) | 60 | 110 | ns |

PIN CONFIGURATION 28-Pin SOJ



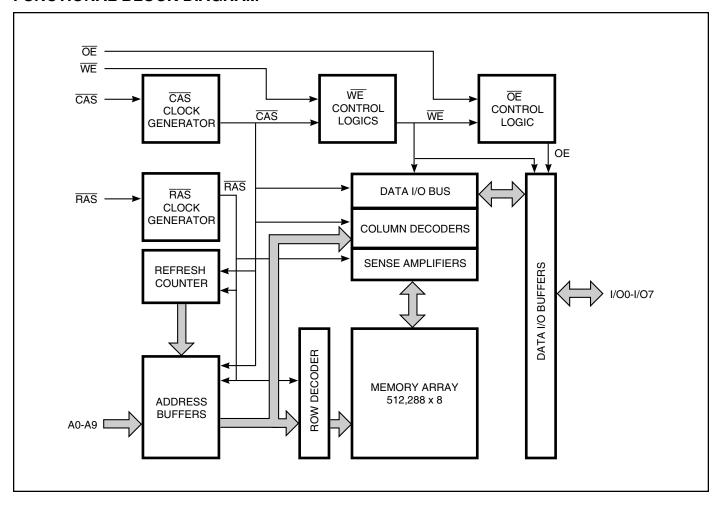
PIN DESCRIPTIONS

| A0-A9 | Address Inputs |
|-----------|-----------------------|
| I/O0-I/O7 | Data Inputs/Outputs |
| WE | Write Enable |
| ŌĒ | Output Enable |
| RAS | Row Address Strobe |
| CAS | Column Address Strobe |
| Vcc | Power |
| GND | Ground |
| NC | No Connection |

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FUNCTIONAL BLOCK DIAGRAM



TRUTH TABLE

| Function | | RAS | CAS | WE | ŌĒ | Address tr/tc | I/O |
|-------------------|----------------------|---------------------------------|-----|-----|-----|---------------|--------------|
| Standby | | Н | Н | Х | Χ | Х | High-Z |
| Read | | L | L | Н | L | ROW/COL | D оит |
| Write: Word (Earl | y Write) | L | L | L | Х | ROW/COL | Din |
| Read-Write | | L | L | H→L | L→H | ROW/COL | Dout, DIN |
| Hidden Refresh | Read | L→H→L | L | Н | L | ROW/COL | D оит |
| | Write ⁽¹⁾ | $L{\rightarrow}H{\rightarrow}L$ | L | L | Χ | ROW/COL | D ouт |
| RAS-Only Refres | h | L | Н | Х | Х | ROW/NA | High-Z |
| CBR Refresh | | H→L | L | Х | Χ | Х | High-Z |

Notes:

1. EARLY WRITE only.



FUNCTIONAL DESCRIPTION

The IS41C85125 and IS41LV85125 are CMOS DRAMs optimized for high-speed bandwidth, low-power applications. During READ or WRITE cycles, each bit is uniquely addressed through the 19 address bits. The first ten address bits (A0-A9) are entered as row address and latter nine address bits (A0-A8) are entered as column address. The row address is latched by the Row Address Strobe (RAS). The column address is latched by the Column Address Strobe (CAS). RAS is used to latch the first ten bits of row address and CAS is used to latch the latter nine bits of column address.

Memory Cycle

A memory cycle is initiated by bringing RAS LOW and it is terminated by returning both RAS and CAS HIGH. To ensure proper device operation and data integrity any memory cycle, once initiated, must not be ended or aborted before the minimum tras time has expired. A new cycle must not be initiated until the minimum precharge time trap, tcp has elapsed.

Read Cycle

A read cycle is initiated by the falling edge of \overline{CAS} or \overline{OE} , whichever occurs last, while holding \overline{WE} HIGH. The column address must be held for a minimum time specified by tar. Data Out becomes valid only when trac, tar, tar, and toer are all satisfied. As a result, the access time is dependent on the timing relationships between these parameters.

Write Cycle

A write cycle is initiated by the falling edge of $\overline{\text{CAS}}$ and $\overline{\text{WE}}$, whichever occurs last. The input data must be valid

at or before the falling edge of $\overline{\text{CAS}}$ or $\overline{\text{WE}}$, whichever occurs last.

Refresh Cycle

To retain data, 1024 refresh cycles are required in each 16 ms period. There are two ways to refresh the memory:

- By clocking each of the 1024 row addresses (A0 through A9) with RAS at least once every 16 ms. Any read, write, read-modify-write or RAS-only cycle refreshes the addressed row.
- Using a CAS-before-RAS refresh cycle. CAS-before-RAS refresh is activated by the falling edge of RAS, while holding CAS LOW. In CAS-before-RAS refresh cycle, an internal 10-bit counter provides the row addresses and the external address inputs are ignored.

CAS-before-RAS is a refresh-only mode and no data access or device selection is allowed. Thus, the output remains in the High-Z state during the cycle.

Power-On

After application of the Vcc supply, an initial pause of 200 μ s is required followed by a minimum of eight initialization cycles (any combination of cycles containing a \overline{RAS} signal).

During power-on, it is recommended that RAS track with Vcc or be held at a valid V_{IH} to avoid current surges.



ABSOLUTE MAXIMUM RATINGS(1)

| Symbol | Parameters | | Rating | Unit |
|--------|------------------------------------|------|--------------|------|
| VT | Voltage on Any Pin Relative to GND | 5V | -1.0 to +7.0 | V |
| | | 3.3V | -0.5 t0 +4.6 | |
| Vcc | Supply Voltage | 5V | -1.0 to +7.0 | V |
| | | 3.3V | -0.5 t0 +4.6 | |
| Іоит | Output Current | | 50 | mA |
| PD | Power Dissipation | | 1 | W |
| Та | Operation Temperature | Com. | 0 to 70 | °C |
| | | Ind. | -40 to +85 | |
| Тѕтс | Storage Temperature | | -55 to +125 | °C |

Note:

RECOMMENDED OPERATING CONDITIONS (Voltages are referenced to GND)

| Symbol | Parameter | Voltage | Min. | Тур. | Max. | Unit |
|--------|---------------------|---------|------|------|-----------|------|
| Vcc | Supply Voltage | 5V | 4.5 | 5.0 | 5.5 | V |
| Vcc | Supply Voltage | 3.3V | 3.0 | 3.3 | 3.6 | V |
| VIH | Input High Voltage | 5V | 2.4 | _ | Vcc + 1.0 | V |
| VIH | Input High Voltage | 3.3V | 2.0 | _ | Vcc + 0.3 | V |
| VIL | Input Low Voltage | 5V | -1.0 | _ | 8.0 | V |
| VIL | Input Low Voltage | 3.3 | -0.3 | _ | 8.0 | V |
| TA | Ambient Temperature | Com. | 0 | _ | 70 | °C |
| | | Ind. | -40 | _ | 85 | |

CAPACITANCE(1,2)

| Symbol | Parameter | Max. | Unit |
|--------|--|------|------|
| CIN1 | Input Capacitance: A0-A9 | 5 | pF |
| CIN2 | Input Capacitance: RAS, UCAS, LCAS, WE, OE | 7 | pF |
| Сю | Data Input/Output Capacitance: I/O0-I/O7 | 7 | pF |

Notes:

1. Tested initially and after any design or process changes that may affect these parameters.

2. Test conditions: $T_A = 25^{\circ}C$, f = 1 MHz.

Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause
permanent damage to the device. This is a stress rating only and functional operation of the
device at these or any other conditions above those indicated in the operational sections of
this specification is not implied. Exposure to absolute maximum rating conditions for
extended periods may affect reliability.



ELECTRICAL CHARACTERISTICS(1) (Recommended Operation Conditions unless otherwise noted.)

| Symbol | Parameter | Test Condition | | | Speed | Min. | Max. | Unit |
|--------|--|---|--------------------------|------------------------------|------------|-------------|------------------|------|
| lı. | Input Leakage Current | Any input $0V \le V_{IN} \le V_{CC}$ Other inputs not under tes | t = 0V | | | -10 | 10 | μΑ |
| lio | Output Leakage Current | Output is disabled (Hi-Z) 0V ≤ Vouт ≤ Vcc | | | | -10 | 10 | μΑ |
| Vон | Output High Voltage Level | lон = −2.5 mA | | | | 2.4 | _ | V |
| Vol | Output Low Voltage Level | IoL = 2.1 mA | | | | _ | 0.4 | V |
| lcc1 | Stand-by Current: TTL | RAS, CAS ≥ ViH | 5V 5V 3.3V 3.3V | Com. Ind. Com. Ind. | | _ _ _ | 2 3 1 2 | mA |
| lcc2 | Stand-by Current: CMOS | RAS, CAS ≥ Vcc – 0.2V | 5V 3.3V | | | _ | 2 | mA |
| lcc3 | Operating Current: Random Read/Write ^(2,3,4) Average Power Supply Current | RAS, CAS, Address Cycling, trc = trc | (min.) | | -35 -60 | _ | 230 170 | mA |
| ICC4 | Operating Current: Fast Page Mode ^(2,3,4) Average Power Supply Current | $\overline{RAS} = V_{IL}, \overline{CAS},$ Cycling tpc = tpc (min.) | | | -35 -60 | _ | 220 160 | mA |
| Iccs | Refresh Current: RAS-Only ^(2,3) Average Power Supply Current | \overline{RAS} Cycling, $\overline{CAS} \ge V_{IH}$ trc = trc (min.) | | | -35 -60 | _ | 230 170 | mA |
| Icce | Refresh Current: CBR ^(2,3,5) Average Power Supply Current | RAS, CAS Cycling trc = trc (min.) | | | -35 -60 | | 230 170 | mA |

Notes:

An initial pause of 200 μs is required after power-up followed by eight RAS refresh cycles (RAS-Only or CBR) before proper device operation is assured. The eight RAS cycles wake-up should be repeated any time the tree refresh requirement is exceeded.

^{2.} Dependent on cycle rates.

^{3.} Specified values are obtained with minimum cycle time and the output open.

^{4.} Column-address is changed once each fast page cycle.

^{5.} Enables on-chip refresh and address counters.



AC CHARACTERISTICS(1,2,3,4,5,6) (Recommended Operating Conditions unless otherwise noted.)

| | | -3 | 5 | -6 | 0 | |
|--------|---|------|------|------|------|-------|
| Symbol | Parameter | Min. | Max. | Min. | Max. | Units |
| trc | Random READ or WRITE Cycle Time | 60 | _ | 110 | _ | ns |
| trac | Access Time from RAS(6, 7) | _ | 35 | _ | 60 | ns |
| tcac | Access Time from CAS(6, 8, 15) | _ | 10 | _ | 15 | ns |
| taa | Access Time from Column-Address ⁽⁶⁾ | _ | 18 | _ | 30 | ns |
| tras | RAS Pulse Width | 35 | 10K | 60 | 10K | ns |
| trp | RAS Precharge Time | 20 | _ | 40 | _ | ns |
| tcas | CAS Pulse Width ⁽²⁶⁾ | 6 | 10K | 10 | 10K | ns |
| tcp | CAS Precharge Time ^(9, 25) | 5 | _ | 10 | _ | ns |
| tcsн | CAS Hold Time (21) | 35 | _ | 60 | _ | ns |
| trcd | RAS to CAS Delay Time(10, 20) | 11 | 28 | 20 | 45 | ns |
| tasr | Row-Address Setup Time | 0 | _ | 0 | _ | ns |
| trah | Row-Address Hold Time | 6 | _ | 10 | _ | ns |
| tasc | Column-Address Setup Time(20) | 0 | _ | 0 | _ | ns |
| tcah | Column-Address Hold Time(20) | 6 | _ | 10 | _ | ns |
| tar | Column-Address Hold Time (referenced to RAS) | 30 | _ | 40 | _ | ns |
| trad | RAS to Column-Address Delay Time(11) | 12 | 20 | 15 | 30 | ns |
| tral | Column-Address to RAS Lead Time | 18 | _ | 30 | _ | ns |
| trpc | RAS to CAS Precharge Time | 0 | _ | 0 | _ | ns |
| trsн | RAS Hold Time ⁽²⁷⁾ | 8 | _ | 15 | _ | ns |
| tcLz | CAS to Output in Low-Z(15, 29) | 3 | _ | 3 | _ | ns |
| tcrp | CAS to RAS Precharge Time(21) | 5 | _ | 5 | _ | ns |
| top | Output Disable Time(19, 28, 29) | 3 | 15 | 3 | 15 | ns |
| toe | Output Enable Time(15, 16) | _ | 10 | _ | 15 | ns |
| toehc | OE HIGH Hold Time from CAS HIGH | 10 | _ | 10 | _ | ns |
| toep | OE HIGH Pulse Width | 10 | _ | 10 | _ | ns |
| toes | OE LOW to CAS HIGH Setup Time | 5 | _ | 5 | _ | ns |
| trcs | Read Command Setup Time(17, 20) | 0 | _ | 0 | _ | ns |
| trrh | Read Command Hold Time (referenced to \overline{RAS}) ⁽¹²⁾ | 0 | _ | 0 | _ | ns |
| trch | Read Command Hold Time (referenced to $\overline{\text{CAS}}$) ^(12, 17, 21) | 0 | _ | 0 | _ | ns |
| twch | Write Command Hold Time(17, 27) | 5 | | 10 | | ns |
| twcr | Write Command Hold Time (referenced to RAS) ⁽¹⁷⁾ | 30 | _ | 50 | _ | ns |

(Continued)



AC CHARACTERISTICS(1,2,3,4,5,6) (Recommended Operating Conditions unless otherwise noted.)

| | | -3 | 35 | -6 | 0 | | |
|--------|--|------|--------------|------|------|-------|--|
| Symbol | Parameter | Min. | Max. | Min. | Max. | Units | |
| twp | Write Command Pulse Width(17) | 5 | _ | 10 | _ | ns | |
| twpz | WE Pulse Widths to Disable Outputs | 10 | _ | 10 | _ | ns | |
| trwL | Write Command to RAS Lead Time(17) | 8 | _ | 15 | _ | ns | |
| tcwL | Write Command to CAS Lead Time(17, 21) | 8 | _ | 15 | _ | ns | |
| twcs | Write Command Setup Time(14, 17, 20) | 0 | _ | 0 | _ | ns | |
| tohr | Data-in Hold Time (referenced to RAS) | 30 | _ | 40 | _ | ns | |
| tach | Column-Address Setup Time to CAS Precharge during WRITE Cycle | 15 | _ | 15 | _ | ns | |
| tоен | OE Hold Time from WE during READ-MODIFY-WRITE cycle(18) | 8 | _ | 15 | _ | ns | |
| tos | Data-In Setup Time(15, 22) | 0 | _ | 0 | _ | ns | |
| tон | Data-In Hold Time(15, 22) | 6 | _ | 10 | _ | ns | |
| trwc | READ-MODIFY-WRITE Cycle Time | 80 | _ | 140 | _ | ns | |
| trwd | RAS to WE Delay Time during READ-MODIFY-WRITE Cycle(14) | 45 | _ | 80 | _ | ns | |
| tcwp | CAS to WE Delay Time(14, 20) | 25 | _ | 36 | _ | ns | |
| tawd | Column-Address to WE Delay Time(14) | 30 | _ | 49 | _ | ns | |
| tpc | Fast Page Mode READ or WRITE Cycle Time(24) | 12 | _ | 25 | _ | ns | |
| trasp | RAS Pulse Width | 35 | 100K | 60 | 100K | ns | |
| tcpa | Access Time from CAS Precharge(15) | _ | 21 | _ | 34 | ns | |
| tprwc | READ-WRITE Cycle Time(24) | 40 | _ | 56 | _ | ns | |
| toff | Output Buffer Turn-Off Delay from $\overline{\text{CAS}}$ or $\overline{\text{RAS}}^{(13,15,19,\ 29)}$ | 3 | 15 | 3 | 15 | ns | |
| twnz | Output Disable Delay from WE | 3 | 15 | 3 | 15 | ns | |
| tclch | Last CAS going LOW to First CAS returning HIGH ⁽²³⁾ | 10 | _ | 10 | _ | ns | |
| tcsr | CAS Setup Time (CBR REFRESH)(30, 20) | 8 | _ | 10 | _ | ns | |
| tchr | CAS Hold Time (CBR REFRESH)(30, 21) | 8 | _ | 10 | _ | ns | |
| tord | OE Setup Time prior to RAS during HIDDEN REFRESH Cycle | 0 | _ | 0 | _ | ns | |
| tref | Refresh Period (1024 Cycles) | | 16 | | 16 | ms | |
| tτ | Transition Time (Rise or Fall)(2, 3) | 1 | 50 | 1 | 50 | ns | |



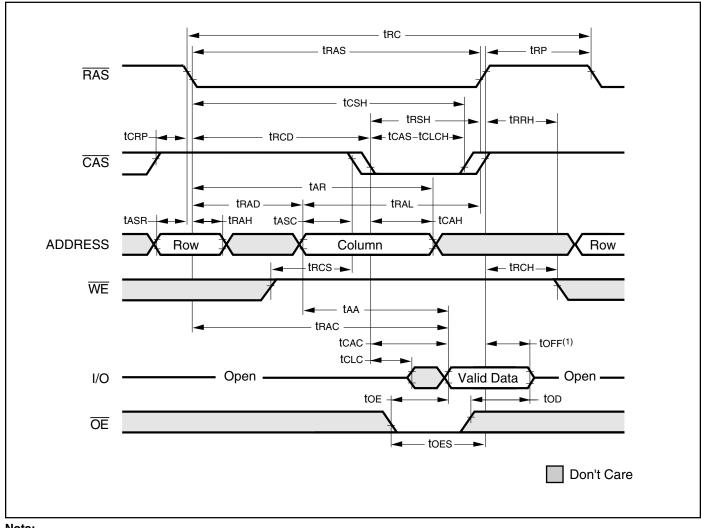
Notes:

- 1. An initial pause of 200 µs is required after power-up followed by eight $\overline{\text{RAS}}$ refresh cycle ($\overline{\text{RAS}}$ -Only or CBR) before proper device operation is assured. The eight $\overline{\text{RAS}}$ cycles wake-up should be repeated any time the tree refresh requirement is exceeded.
- 2. VIH (MIN) and VIL (MAX) are reference levels for measuring timing of input signals. Transition times, are measured between VIH and VIL (or between VIL and VIH) and assume to be 1 ns for all inputs.
- 3. In addition to meeting the transition rate specification, all input signals must transit between V_{IH} and V_{IL} (or between V_{IL} and V_{IH}) in a monotonic manner.
- If CAS and RAS = V_{IH}, data output is High-Z.
- 5. If $\overline{CAS} = V_{IL}$, data output may contain data from the last valid READ cycle.
- 6. Measured with a load equivalent to one TTL gate and 50 pF.
- 7. Assumes that tRCD tRCD (MAX). If tRCD is greater than the maximum recommended value shown in this table, tRAC will increase by the amount that tRCD exceeds the value shown.
- 8. Assumes that trco trco (MAX).
- 9. If $\overline{\text{CAS}}$ is LOW at the falling edge of $\overline{\text{RAS}}$, data out will be maintained from the previous cycle. To initiate a new cycle and clear the data output buffer, $\overline{\text{CAS}}$ and $\overline{\text{RAS}}$ must be pulsed for tcp.
- 10. Operation with the tRCD (MAX) limit ensures that tRAC (MAX) can be met. tRCD (MAX) is specified as a reference point only; if tRCD is greater than the specified tRCD (MAX) limit, access time is controlled exclusively by tCAC.
- 11. Operation within the trad (MAX) limit ensures that trad (MAX) can be met. trad (MAX) is specified as a reference point only; if trad is greater than the specified trad (MAX) limit, access time is controlled exclusively by trad.
- 12. Either trich or trich must be satisfied for a READ cycle.
- 13. toff (MAX) defines the time at which the output achieves the open circuit condition; it is not a reference to Voh or Vol.
- 14. twcs, trwb, tawb and tcwb are restrictive operating parameters in LATE WRITE and READ-MODIFY-WRITE cycle only. If twcs twcs (MIN), the cycle is an EARLY WRITE cycle and the data output will remain open circuit throughout the entire cycle. If trwb trwb (MIN), tawb tawb (MIN) and tcwb tcwb (MIN), the cycle is a READ-WRITE cycle and the data output will contain data read from the selected cell. If neither of the above conditions is met, the state of I/O (at access time and until CAS and RAS or OE go back to Vih) is indeterminate. OE held HIGH and WE taken LOW after CAS goes LOW result in a LATE WRITE (OE-controlled) cycle.
- 15. Output parameter (I/O) is referenced to corresponding CAS input,
- 16. During a READ cycle, if OE is LOW then taken HIGH before CAS goes HIGH, I/O goes open. If OE is tied permanently LOW, a LATE WRITE or READ-MODIFY-WRITE is not possible.
- 17. Write command is defined as $\overline{\text{WE}}$ going low.
- 18. LATE WRITE and READ-MODIFY-WRITE cycles must have both top and toeh met (OE HIGH during WRITE cycle) in order to ensure that the output buffers will be open during the WRITE cycle. The I/Os will provide the previously written data if CAS remains LOW and OE is taken back to LOW after toeh is met.
- 19. The I/Os are in open during READ cycles once top or toff occur.
- 20. The first $\chi \overline{\text{CAS}}$ edge to transition LOW.
- 21. The last $\chi \overline{CAS}$ edge to transition HIGH.
- 22. These parameters are referenced to CAS leading edge in EARLY WRITE cycles and WE leading edge in LATE WRITE or READ-MODIFY-WRITE cycles.
- 23. Last falling $\chi \overline{CAS}$ edge to first rising $\chi \overline{CAS}$ edge.
- 24. Last rising $\chi \overline{CAS}$ edge to next cycle's last rising $\chi \overline{CAS}$ edge.
- 25. Last rising $\chi \overline{CAS}$ edge to first falling $\chi \overline{CAS}$ edge.
- 26. Each χCAS must meet minimum pulse width.
- 27. Last $\chi \overline{CAS}$ to go LOW.
- 28. I/Os controlled, regardless of CAS.
- 29. The 3 ns minimum is a parameter guaranteed by design.
- 30. Enables on-chip refresh and address counters.



AC WAVEFORMS

FAST-PAGE-MODE READ CYCLE

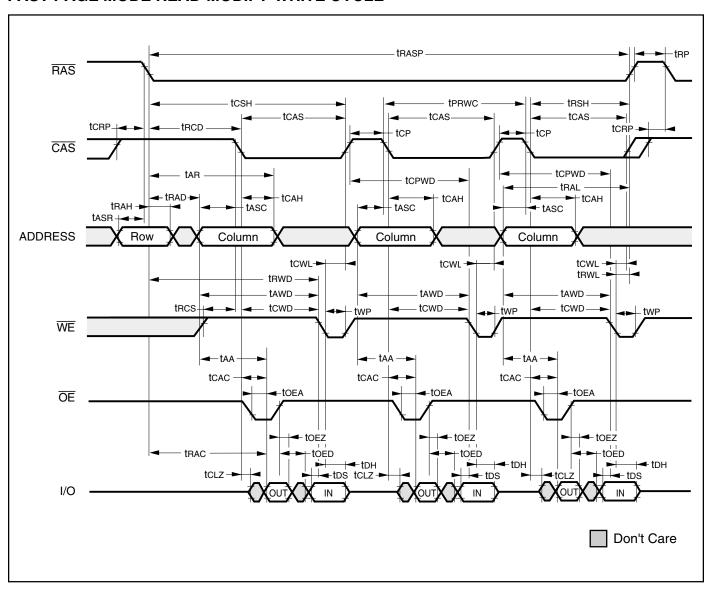


Note:

1. toff is referenced from rising edge of $\overline{\text{CAS}}$.

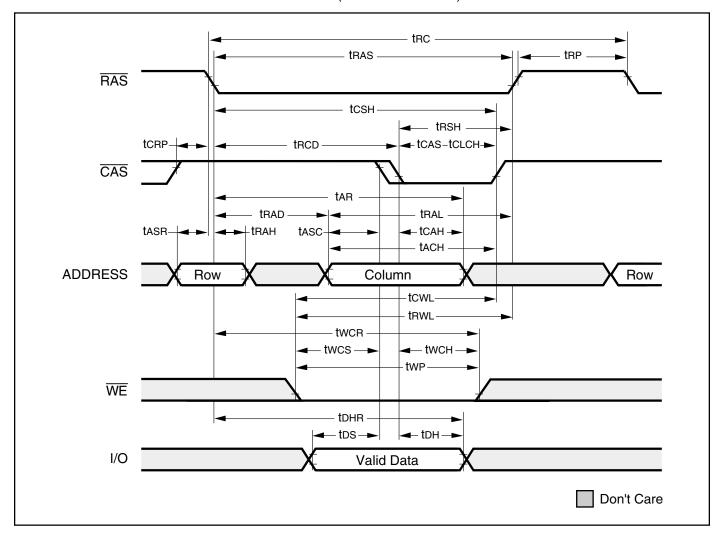


FAST PAGE MODE READ-MODIFY-WRITE CYCLE



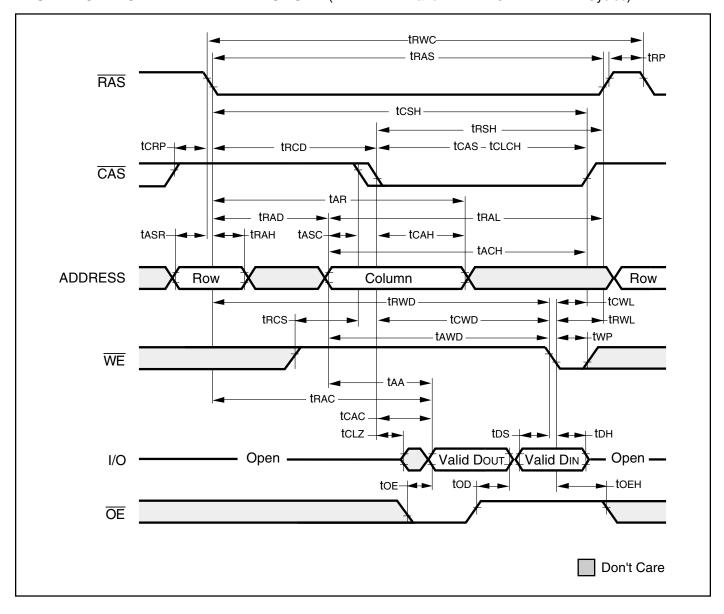


FAST-PAGE-MODE EARLY WRITE CYCLE (OE = DON'T CARE)



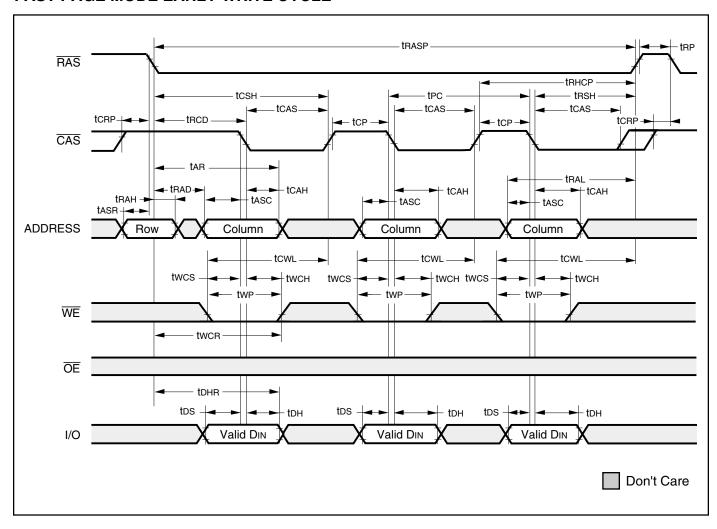


FAST-PAGE-MODE READ WRITE CYCLE (LATE WRITE and READ-MODIFY-WRITE Cycles)



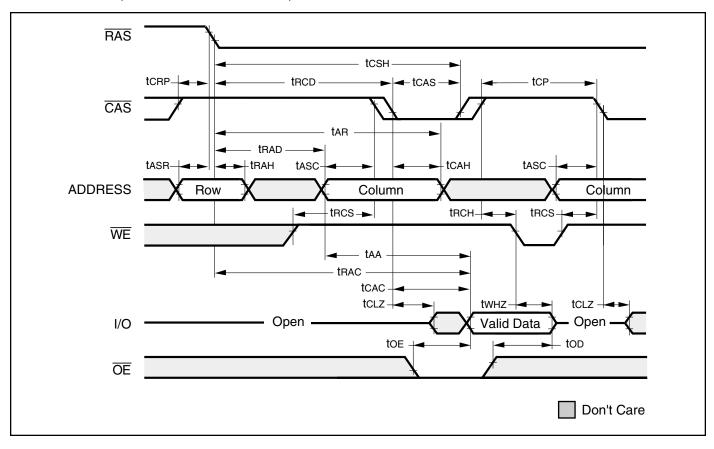


FAST PAGE MODE EARLY WRITE CYCLE

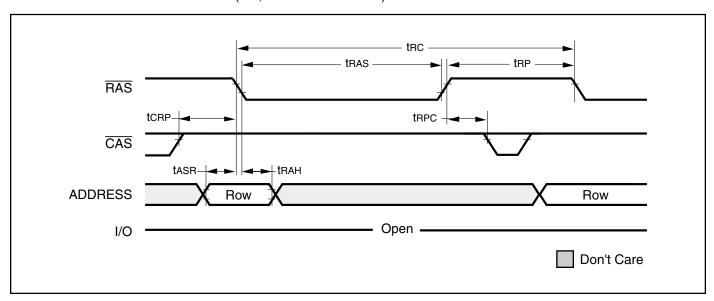




READ CYCLE (With WE-Controlled Disable)

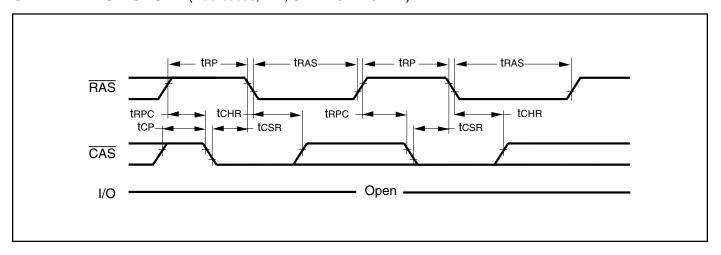


RAS-ONLY REFRESH CYCLE (OE, WE = DON'T CARE)

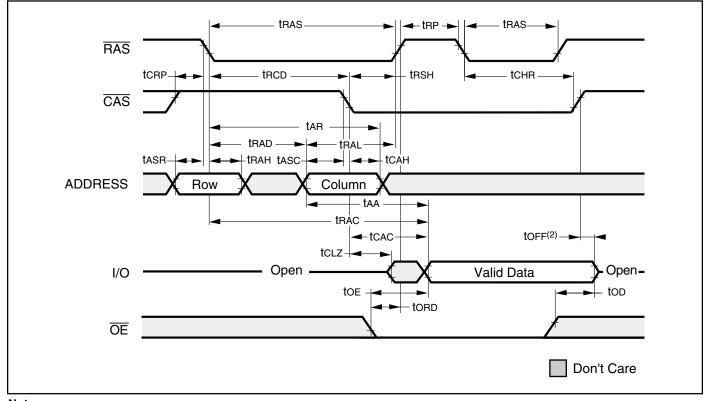




CBR REFRESH CYCLE (Addresses; WE, OE = DON'T CARE)



HIDDEN REFRESH CYCLE(1) (WE = HIGH; OE = LOW)



Notes:

- 1. A Hidden Refresh may also be performed after a Write Cycle. In this case, $\overline{WE} = LOW$ and $\overline{OE} = HIGH$.
- 2. toff is referenced from rising edge of RAS or CAS, whichever occurs last.



ORDERING INFORMATION IS41C85125

Commercial Range: 0.C to 70.C

| Speed (ns) | Order Part No. | Package |
|------------|----------------|---------------------|
| 35 | IS41C85125-35K | 28-pin, 400-mil SOJ |
| 60 | IS41C85125-60K | 28-pin, 400-mil SOJ |

IS41LV85125

Commercial Range: 0.C to 70.C

| Speed (ns) | Order Part No. | Package |
|------------|-----------------|---------------------|
| 35 | IS41LV85125-35K | 28-pin, 400-mil SOJ |
| 60 | IS41LV85125-60K | 28-pin, 400-mil SOJ |

Industrial Range: -40·C to 85·C

| Speed (ns) | Order Part No. | Package |
|------------|-----------------|---------------------|
| 35 | IS41C85125-35KI | 28-pin, 400-mil SOJ |
| 60 | IS41C85125-60KI | 28-pin, 400-mil SOJ |

Industrial Range: -40·C to 85·C

| Speed (ns) | Order Part No. | Package |
|------------|------------------|---------------------|
| 60 | IS41LV85125-60KI | 28-pin, 400-mil SOJ |



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